



Surface Mount Resettable PTCs

SCF030-2920RB

Features

u RoHS Compliant & Halogen Free

 Faster tripping, 2920 Dimension, Surface mountable, Solid state

u Operation Current: 0.30Au Maximum Voltage: 60.0Vdc

u Operating Temperature: -40° C $\sim +85^{\circ}$ C **u** Agency recognition: UL/CSA/TUV



Electrical Parameters

Part Number	Hold Current	Trip Current	Rated Voltage	Max Current	Typical Power	Maximum Time To Trip		Resistance		
, and manuscr	I hold (A)	I trip (A)	V _{max} (Vdc)	I _{max} (A)	P _{dtyp} . (W)	Current (A)	Time (Sec.)	R _{min} (Ω)	R _{typ} (Ω)	R _{1max} (Ω)
SCF030-2920RB	0.30	0.60	60.0	100	1.50	1.50	3.00	0.600	0.900	4.800

I hold = Hold Current. Maximum current device will not trip in 25°C still air.

I $_{trip}$ = Trip Current. Minimum current at which the device will always trip in 25°C still air.

V_{max} = Maximum operating voltage device can withstand without damage at rated current (Imax).

I max = Maximum fault current device can withstand without damage at rated voltage (Vmax).

P dyp =Maximum power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

R _{min/typ} = Minimum/Typical device resistance prior to tripping at 25°C.

R _{1max} = Maximum device resistance is measured one hour post reflow.

Test Conditions and Standards

Test Item	Test Condition	Standard		
Initial Resistance	25℃	0.600~4.800Ω		
I _H	25 ℃, 0.30 A, 60min	No trip		
T _{trip}	25℃, 1.50A	≤3.0s		
Trip Endurance	60.0V, 100A, 1hr	No arcing or burning		

Physical Characteristics

Terminal Pad Materials	Tin-Plated Nickle-copper
Terminal Pad Solderability	Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

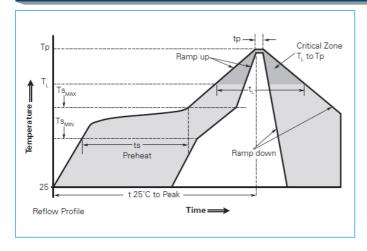




Surface Mount Resettable PTCs

SCF030-2920RB

Soldering Parameters



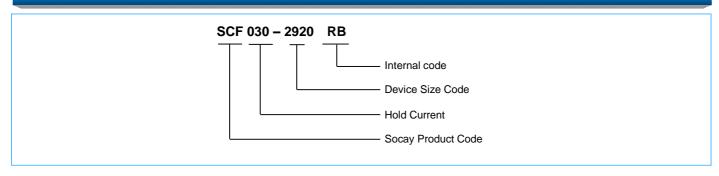
	i
Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (T _S max to T _P)	3℃/second max.
Preheat: Temperature Min (T _S min) Temperature Max (T _S max) Time (T _S min to T _S max)	150℃ 200℃ 60-120 seconds
Time maintained above: Temperature(T _L) Time (T _L)	217°C 60-150 seconds
Peak/Classification Temperature(T _P)	260℃
Time within 5 ℃ of actual peak temperature: Time (T _P)	30 seconds max.
Ramp-down Rate	3℃/ second max.
Time 25℃ to Peak Temperature	8 minutes max.

- Recommended reflow methods: I_R, vapor phase oven, hot air oven, N2 environment for lead-free.
- I Devices are not designed to be wave soldered to the bottom side of the board.
- I Recommended maximum paste thickness is 0.25mm (0.010inch).
- I Devices can be cleaned using standard industry methods and solvents.
- I Soldering temperature profile meets RoHS leadfree process.

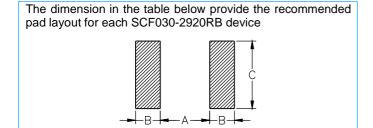
Note 1: All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperature exceed the recommended profile devices may not meet the performance requirements.

Part Numbering



Recommended Solder Pad Layout Dimensions (Unit: mm)



Device	A	В	С
2920 Series	5.1±0.1	2.3±0.1	5.6±0.1

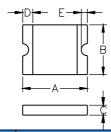




Surface Mount Resettable PTCs

SCF030-2920RB

Product Dimensions (Unit: mm)



Part Number	Α		В		С		D
Part Number	Min.	Max.	Min.	Max.	Min.	Max.	Min.
SCF030-2920RB	6.73	7.98	4.80	5.44	0.60	1.15	0.30

Packaging Quantity

Part Number	Packaging Option	Quantity
SCF030-2920RB	Tape & Reel	2000 PCS

Warning



- Operation beyond the specified maximum ratings or improper use may result in damage and possible electrical arcing and/or flame.
- **u** PPTC device are intended for occasional over-current protection. Application for repeated over-current condition and/or prolonged trip are not anticipated.
- Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.